

深圳市索瑞达电子有限公司

承 认 书 SPECIFICATION FOR APPROVAL

客 户 名 称: Customer Name :	立创	
客户料号: Customer P/N:		
产 品 名 称: Product Name:	功率电感	
索瑞达料号: Sorede P/N:	SDRH.5D28.LF151MT00	





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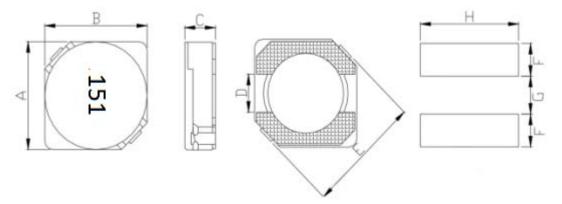
修改履历表

Modify Resume

	Modity Resume	
修改日期	修改明细	修改后版本号
Date modified	Modify Details	Version No.
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1、外形尺寸 Dimension:



单位Unit: mm

A	5.7±0.3			
В	5.7±0.3			
С	3.00 Max.			
D	2.00 Ref.			
Е	8.20 Ref.			
F	2.15 Ref.			
G	2.00 Ref.			
Н	6.30 Ref.			

2、产品品名构成 Product Spec. Model

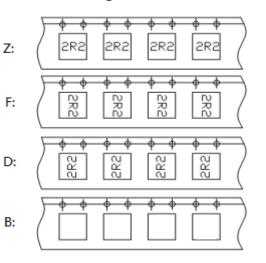
<u>SDRH</u> <u>5D28</u> <u>L</u> <u>F</u> <u>151</u> <u>M</u> <u>T</u> <u>00</u> a b c d e f g h

- a: 系列名称Series name
- b: 产品尺寸Product dimensions (AxBxC)
- c: 密封方式Sealing way (L: 冷封Cold seal Y: 热封Heat seal)
- d: 印字方向 Lettering direction ▶
- e: 电感值Inductance Value

(1R0:1.0uH; 100: 10uH; 101:100uH)

- f: 电感公差Inductance Tolerance (K:10%; M:20%; N:30%)
- g: 包装Package(T:磁带/卷轴Tape/Reel、B: 散装Bulk)
- h: 编号Numbering (标准standard)

► Lettering direction



3、材料清单MATERIAL LIST

NO.	PARTS	MATERIAL SPECIFICATIONS	UL FILE NO.	TEMP. CLASS
1	CORE	DRB5.7-4.1-2.7-2.0 SI5.7-2.45-4.7 EQUIVALENT	NA	NA
2	WIRE	2UEWH P180 OR EQUIVALENT	E258243	180℃
3	ADHESIVE	G 500HF OR EQUIVALENT	NA	NA
4	BASE	C-5D28-P3	NA	NA
5	SOLDER	99.7Sn 0.3Cu OR EQUIVALENT	NA	NA

^{*}NA:NOT APPLICABLE.

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4、电性能参数表 Electrical Characteristics List

规格型号 Part NO.	电感量 Tolerance (uH)	测试频率 Test Freq. (kHz/v)	直流电阻 DCR Max (Ω)	饱和电流 Isat (A)
SDRH.5D28.LF151MT00	150	100/0.25	0.680	0.35

[※]公差Tolerance: N:±30%、M:±20%、K:±10%.

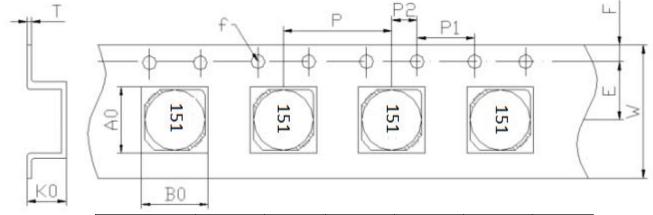
Isat 电流:指使电感量比初始值下降35%Max(The rated DC current is that which cause at 35%Max inductance reduction from the initial value)。

[※]工作温度Operating temperature rang: -40 ℃ to +105℃ (Including Self-heating)

[※]储存温度Storage termperature rang: -40 ℃ to +125℃

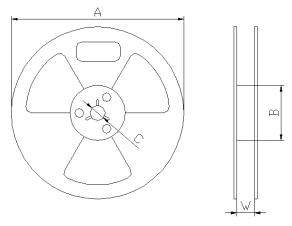
5、产品包装 Packaging

1) 载带包装示意图 Tape packing diagram



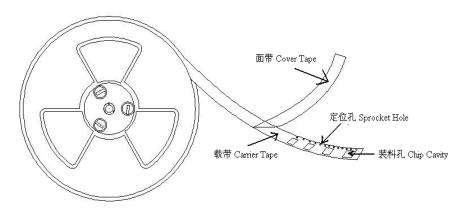
Series	A0	В0	W	Е	F	∮f
Series	6.2±0.1	6.2±0.1	16.0±0.3	5.5±0.1	1.75±0.1	1.5±0.1
CDDHED301E	Р	P1	P2	K0	Т	
SDRH5D28LF	8.0±0.1	4.0±0.1	2.0±0.1	3.2±0.1	0.35±0.1	

2)卷盘包装示意图 Tape packing diagram



А	330±0.5
В	100±0.5
С	13.5±0.5
W	16.5±0.5

3) 卷盘包装示意图 Tape packing diagram

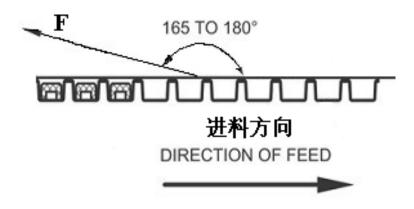


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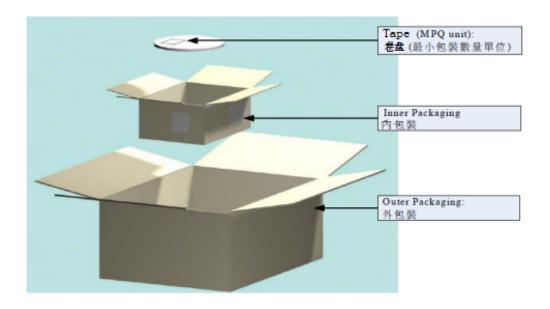
4) 剥离强度要求Peeling required

①F 力大小: 20~100g;

②面带剥离角度: 165°~180°。



5) 包装数量 Packing quantity



项目 (Project)	数量(PCS)	尺寸规格(Size:mm)
盘(Reel)	2000	13"
内盒 (Inner box)	6000	340mm*340mm*65mm
外箱 (Out box)	18000	360mm*360mm*225mm

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6. RELIABILI	Y TEST METHOD							
MECHANICA	L							
TEST ITEM	SPECIFICATION			TEST DETAILS				
Substrate bendi	r △L/Lo≦±5%	The san	The sample shall be soldered onto the printed circuit board					
		in figure	in figure 1 and a load applied unitil the figure in the arrow					
	There shall be	direction is made approximately 3mm.(keep time 30 seconds)						
	no mechanical	PCB dimension shall the page 7/9						
	damage or elec-	F(Pressurization)						
	trical damege.							
				<u> </u>				
		R5 45±2 45±2						
			PRESSURE I figure-1	ROD	20 R340			
Vibration	△L/Lo≦±5%	The san	nple shall be soldered	onto the printed c	ircuit board			
		and wh	en a vibration having a	n amplitude of 1.5	52mm			
	There shall be	and a frequency of from 10 to 55Hz/1 minute repeated should						
	no mechanical	be applied to the 3 directions (X,Y,Z) for 2 hours each.						
	damage.	(A total of 6 hours)						
Solderability	New solder	Flux (ro	sin, isopropyl alcohol{	JIS-K-1522}) shall	be coated			
	More than 90%	over the whole of the sample before hard, the sample shall						
		then be	preheated for about 2	minutes in a temp	perature of			
		130~15	$50^\circ\!$	een immersed to	a depth 0.5mm			
		below fo	or 3±0.2 seconds fully	in molten solder N	/1705 with			
	1	ı						

a temperature of 245±2°C.

the solder bath.

More than 90% of the electrode sections shall be couered

with new solder smoothly when the sample is taken out of

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MECHANIC	AL					
TEST ITEM	SPECIFICATION					
Resistance to	There shall be	Tempe	rature profile of re	flow soldering		
Soldering heat	no damage or					
(reflow soldering)	problems.	150	e-heating 2 min passed through tabove profile for 1 stored at standar	Slow c (Store temper temper time.	d at room ature) more h the	
ELECTRICA	1	I	TEOT DETAIL			
TEST ITEM	SPECIFICATION There shall be no other	DC 400) () # 15 1. 11.1	TEST DETAI			
Insulation resistance	damage or problems.	DC 100V voltage shall the surface and the terminal	• •	uns sample of to	Þ	
esistance		The insulation resistance		than 1 × 10 ⁸ Ω.		
 Dielectric	There shall be	AC 100V voltage shall b	be applied for 1 m	ninute acrosset the	e top	
withstand	no other	surface and the termina			•	
voltage	damage or problems.					
Temperature	△L/L20°C ≦±10%	The test shall be perfore	med after the san	nple has stabilized	d in	
	1	F .				

an ambient temperature of - 40 to + 105°C, and the value

temperature and narmal humidity shall be $\triangle L/L$ 20°C $\leq \pm$ 10%.

calculated based on the value applicable in a normal

characteristics

0~2000 ppm/°C

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TEST ITEM	NT CHARACTERISTICS SPECIFICATION							
High temperature	∆L/Lo≦±5%	The sample s	The sample shall be left for 500hours in an atmospere with					
storage			a temperature of 105±2℃ and a normal humidity.					
Ü	There shall be		ion of the measurement sha	•				
	no mechanical		sample has been left in a normal temperature and normal					
	damage.	humidity for 1	•					
Low temperature	△L/Lo≦±5%	The sample s	hall be left for 500 hours in a	an atmosphere with				
storage		a temperature	of -40±3℃.					
	There shall be	Upon complet	ion of the test, the measure	ement shall be made				
	no mechanical	after the samp	ole has been left in a norma	I temperature and				
	damage.	normal humid	ity for 1 hour.					
Change of	△L/Lo≦±5%	The sample s	The sample shall be subject to 5 continuos cycles, such as shown					
temperature		in the table 2	in the table 2 below and then it shall be subjected to standard					
	There shall be	stmospheric o	stmospheric conditions for 1 hour, after which measurement					
	no other dama-	shall be made	shall be made.					
	ge of problems							
			table 2					
			Temperature	Duration				
		1	−40±3°C	10 min.				
			(Themostat No.1)					
		2	Standard	5 sec. or less				
			atmospheric	No.1→No.2				
		3	105±2℃	30 min.				
			(Themostat No.2)					
		4	Standard	5 sec. or less				
			atmospheric	No.2→No.1				
Moisuture storage		The sample s	hall be left for 500 hours in	a temperature of				
molodiale stolage		·	The sample shall be left for 500 hours in a temperature of $40\pm2^{\circ}$ C and a humidity(RH) of $90\sim95\%$.					
	There shall be		Upon completion of the test, the measurement shall be made					
	no mechanical							
	damage.		after the sample has been left in a normal temperature and normal humidity more than 1 hour.					

The sample shall be reflow soldered onto the printed circuit board in every test.

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7、注意事项 Note

①本承认书保证我司产品作为一个单体时的质量情况。当我司产品被安装到贵司产品上时,请保证 贵司的产品已根据贵司的规范进行了有效评估和确认。

This product specification guarantees the quality of our product as a single unit. Please make sure that your product is evaluated and confirmed against your specifications when our product is mounted to your product.

②如果贵司对我司产品的使用已超过了本承认书所界定的产品功能,那么对于由此引发的失效, 我司将不予保证。

We cannot warrant against failure caused by any use of our product that deviates from the intended use as described in this product specification.

- ③为了保持终端电极的焊接性,并使包装材料保持良好状态,必须控制储存区的温度和湿度。
 To maintain the solderabilty of terminal electrodes and to keep the packing material in good condition, temperature and humidity in the storage area should be controlled.
 - ※建议的条件: -10~+40℃, 30~70%RH。

Recommended conditions: -10 \sim +40 $^{\circ}$ C, 30 \sim 70%RH.

※储存超过六个月的,应在实际使用前进行焊接检验。
In case of storage over 6 months, soldrability shall be checked before actual usage.

※即使在理想的储存条件下,产品的可焊性也随着时间的推移而降低。因此,产品应从交货时算起, 建议8个月之内使用完。

Even under ideal storage conditions, the weldability of the product decreases over time. therefore, the product should be From the time of delivery, it is recommended that it be used within 8 months.

④本承认书在客户收到30天之内,必须签章返回,逾期视为默认。

The Specification Approval should be sent back to the supplier with customer's chop on it within 30 days after receiving it, or we will take it as approved by customer's automatically.

⑤如有特殊规格要求,请事前联络我司技术部人员。

In case of special specifications please contact our technical department prior staff.